

MOSFET

OptiMOS™3 Power-MOSFET, 80 V

Features

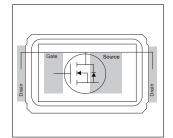
- Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 Low profile (<0.7mm)
 Dual sided cooling

- Low parasitic inductance
- N-channel, normal level

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ extsf{DS}}$	80	V
$R_{ extsf{DS(on)}, ext{max}}$	10.4	mΩ
I _D	50	A











Type / Ordering Code	Package	Marking	Related Links
BSB104N08NP3 G	MG-WDSON-2	0308	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damamatan	Oh a l	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I _D	- - -	-	50 32 13	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =45 K/W ¹⁾
Pulsed drain current ²⁾	I _{D,pulse}	-	-	200	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ³⁾	E AS	-	-	110	mJ	$I_{\rm D}$ =30 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	42 2.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =45 K/W ¹⁾
Operating and storage temperature	T _j , T _{stg}	-40	-	150	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	1.0	-	K/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	3.0	K/W	-
Device on PCB, 6 cm ² cooling area ¹⁾	R _{thJA}	-	-	45	K/W	-

 $^{^{1)}}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air. $^{2)}$ See Diagram 3 for more detailed information $^{3)}$ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.0	2.7	3.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=40\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	10 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	9.3	10.4	mΩ	V _{GS} =10 V, I _D =10 A
Gate resistance	R _G	-	2	-	Ω	-
Transconductance	g fs	23	46	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 30 \text{ A}$

Table 5 **Dynamic characteristics**

Davamatav	Or made al	Values				Nata (Tant One With an
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	1600	2100	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance	Coss	-	430	570	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	29	44	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	9	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	19	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics¹⁾

Parameter	Cumbal	Values			l lmi4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	8	11	nC	V_{DD} =40 V, I_{D} =30 A, V_{GS} =0 to 10 V
Gate to drain charge	Q _{gd}	-	5	8	nC	V_{DD} =40 V, I_{D} =30 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	8	13	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total	Qg	-	23	31	nC	V_{DD} =40 V, I_{D} =30 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.0	-	V	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Output charge	Qoss	-	31	42	nC	V _{DD} =40 V, V _{GS} =0 V

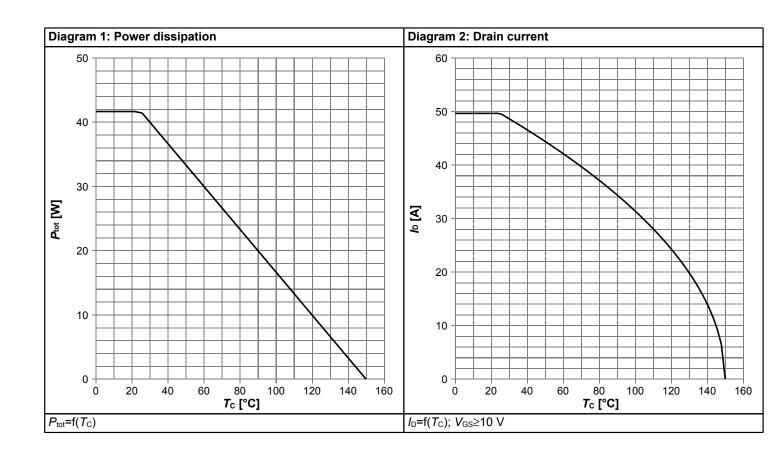


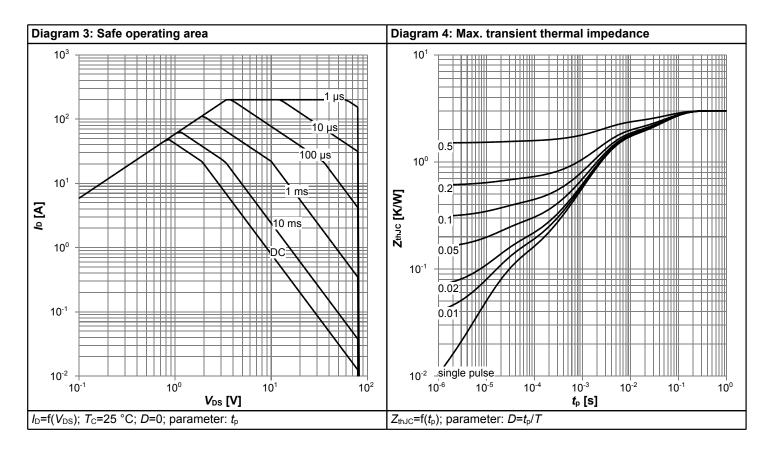
Table 7 Reverse diode

Davamatan	Cumbal		Values			Nata / Tant Canadition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	30	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	200	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.9	1.2	V	V _{GS} =0 V, I _F =30 A, T _j =25 °C
Reverse recovery time	t _{rr}	-	43	-	ns	V _R =40 V, I _F =30 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge	Qrr	-	55	-	nC	V_R =40 V, I_F =30 A, di_F/dt =100 A/ μ s

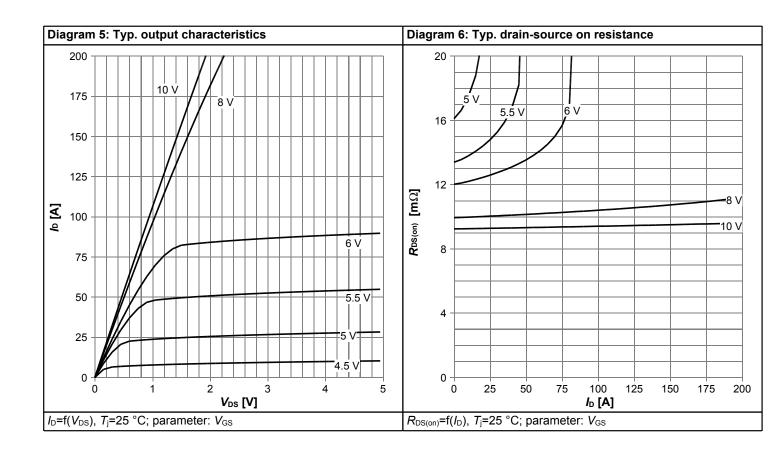


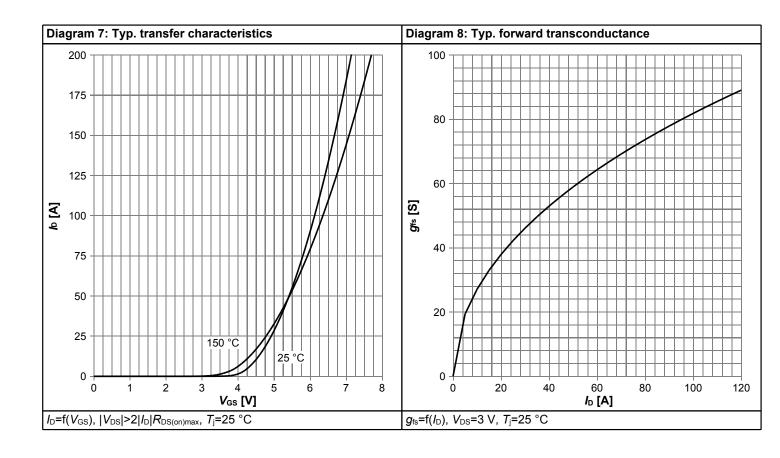
4 Electrical characteristics diagrams



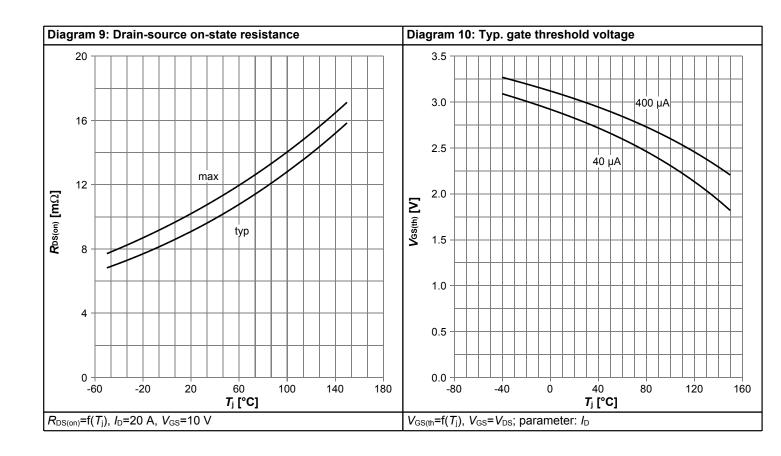


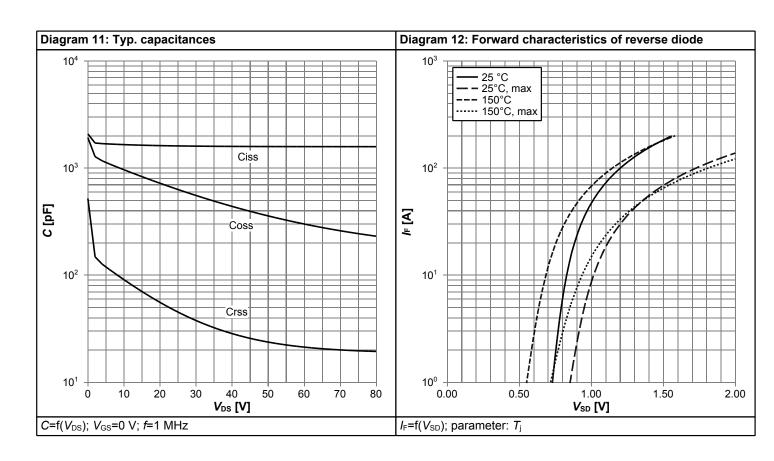




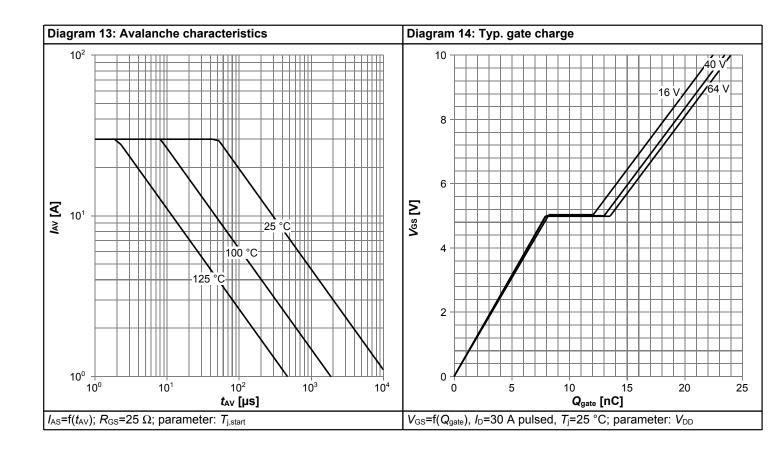


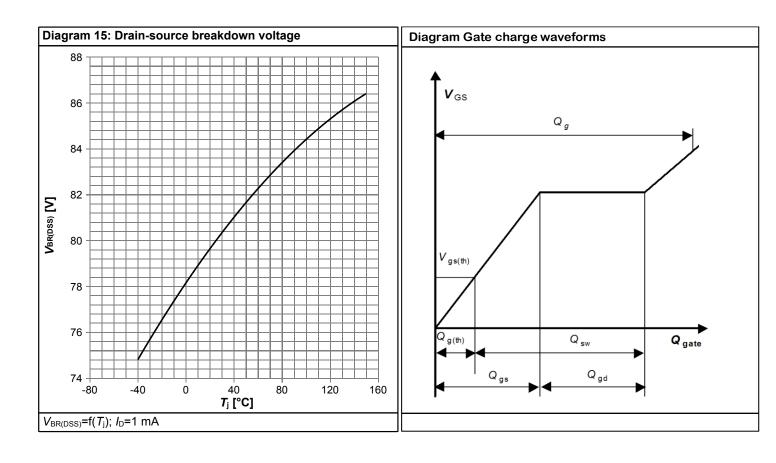














5 Package Outlines

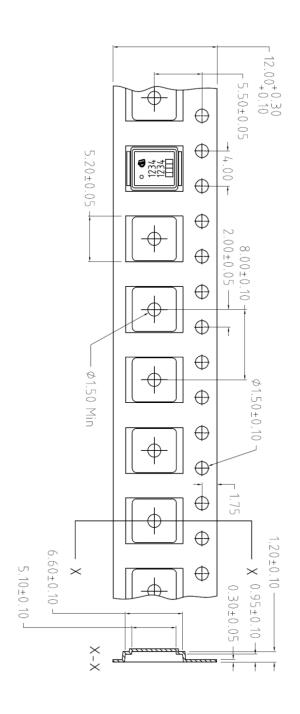


Figure 1 Outline Tape (CanPAK M)



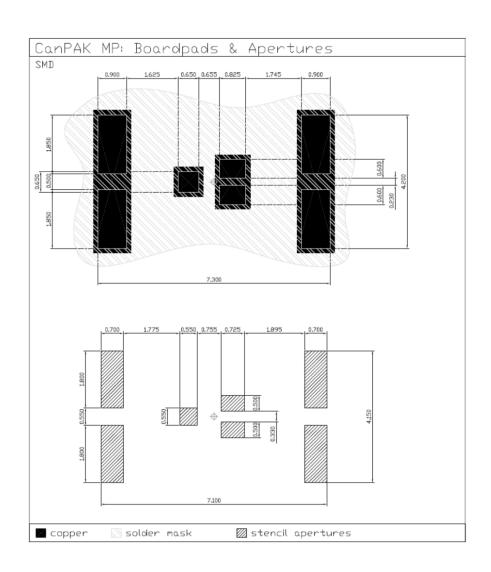


Figure 2 Outline Boardpads (CanPAK M)



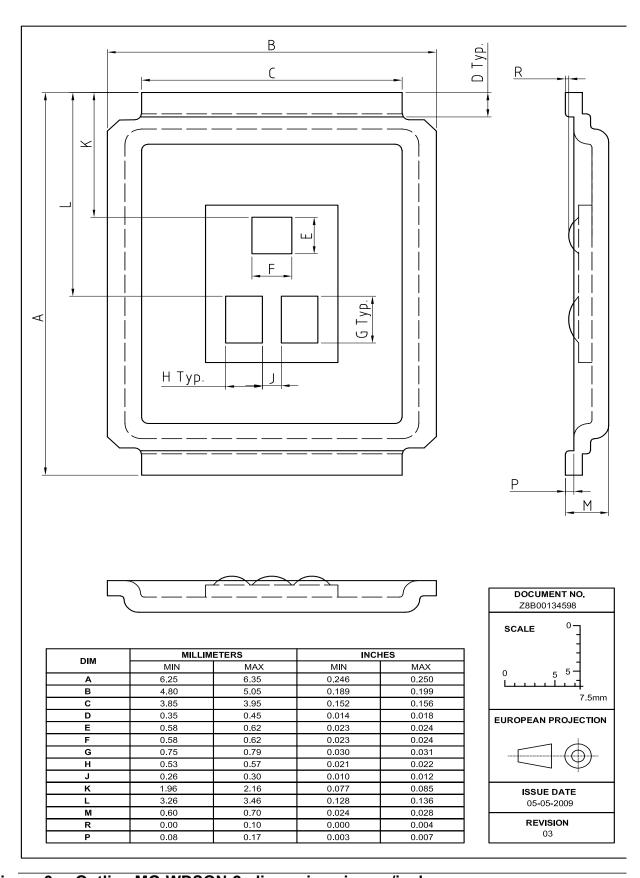


Figure 3 Outline MG-WDSON-2, dimensions in mm/inches



Revision History

BSB104N08NP3 G

Revision: 2018-11-15, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.2	2018-11-15	Update model

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